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10/046693

1/17/02

U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

FIG 1

APPL NUM 10046693	FILING DATE 01/17/2002	CLASS 264	SUBCLASS 313	GAU 1732	EXAMINER KUNAS
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**APPLICANTS: Lee Yeou-Ching; Wang Ming-Cheng;

**CONTINUING DATA VERIFIED:

THIS APPLICATION IS A CIP OF 09/680,295 10/06/2000 PAT 6,337,044

** FOREIGN APPLICATIONS VERIFIED:

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PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no	35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO P65993US1
Verified and Acknowledged Examiners's initials		
TITLE : Molding process for manufacturing a molded article		

U.S. DEPT. OF COMM./PAT. & TM-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
Assistant Examiner			
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drawn	Figs. Drawn
Primary Examiner		Application Examiner	
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	
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